Spec. No.: FCC-K-HTS-0003 /13

Date: 2017. 1. 10

Specification

Title: CHIP FUSE; RECTANGULAR TYPE

Style: FCC10,16,20,32, FHC10,16,20,32

RoHS COMPLIANCE ITEM
Halogen and Antimony Free

Product specification contained in this specification are subject to change at any time without notice If you have any questions or a Purchasing Specification for any quality Agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

Note: Stock conditions

Temperature: $+5^{\circ}\text{C} \sim +35^{\circ}\text{C}$ Relative humidity: $25\% \sim 75\%$

The period of guarantee: Within 2 year from shipmen t by the company.

Solderability shall be satisfied.

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1. Scope

1.1 This specification covers the detail requirements for chip fuses; rectangular type, style of FCC10,16,20,32, FHC10,16,20,32.

1.2 Applicable documents

UL248-1-2000 Low-Voltage Fuses-Part1: General Requirements

UL248-14-2000 Low-Voltage Fuses-Part14: Supplemental Fuses

CSA C22.2 No.248.1–2000 Low-Voltage Fuses-Part1: General Requirements

CSA C22.2 No.248.14–2000 Low-Voltage Fuses-Part14: Supplemental Fuses

IEC60127-1 Miniature fuses-part 1: Definitions for miniature fuses and general requirements for miniature fuse-links

IEC60127-4 Miniature fuses-Part4: Universal modular fuse-links (UMF)

2. Classification

Type designation shall be the following form.

(Example

2 Size

3 Rated current

4 Optional code

Symbol	Content			
AB	Charadard			
AD	Standard			

5 Packaging form

В	Bulk (loose package)
PA	Press pocket taping
TP	Paper taping

3. Safety standard approval

- UL248-1 and UL248-14
- CSA C22.2, No. 248.1–00 and CSA C22.2, No. 248.14–00

The file number to be designated by UL and C-UL shall be as follows: E176847

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4. Rating

The ratings shall be in accordance with Table-1.

4.1 Optional code: AB

Table-1(1)

Rated current			nt	Internal resistance value	Rated	Breaking	Time / current characteristic	
Style	Symbol	(A)	Marking symbol	(m Ω max.)	voltage (V)	capacity (A)	Current	Pre-arcing time
	201	0.2	Z	2400				
	251	0.25	С	1000				
	321	0.315	D	750				
	401	0.4	E	620				
	501	0.5	F	340				
F0040	631	0.63	I	290	D 000			
FCC10	751	0.75	A	220	DC30		0000/	_
	801	0.8	K	210		35	200%	5 s max.
	102	1.0	L	150				
	132	1.25	M	120				
	152	1.5	Н	100	DC24			
	162	1.6	N	90				
E1 10 10	202	2.0	S	55				
FHC10	252	2.5	Т	40	DC24			
	201	0.2	ZB	3,200	DC36	35		5 s max.
	251	0.25	СВ	1,800				
	321	0.315	DB	1,000				
	401	0.4	EB	750			200%	
	501	0.5	FB	330				
	631	0.63	ΙB	280				
FCC16	751	0.75	AB	210				
	801	0.8	KB	200				
	102	1.0	LB	130				
	132	1.25	MB	110				
	152	1.5	HB	95				
	162	1.6	NB	85				
	202	2.0	SB	70				
FHC16	252	2.5	TB	40	DC32			
	501	0.5	FB	330				
	631	0.63	IB	270				
	801	8.0	KB	190				
FCC20	102	1.0	LB	130	DC50	50	2000/	5 c mov
	132	1.25	MB	100		30	200%	5 s max.
	162	1.6	NB	80				
	202	2.0	SB	65				
FHC20	252	2.5	TB	40	DC32			

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4.2 Optional code: AD

Table-1(2)

Table-1(2)								
Style	R	ated curre	nt	Internal resistance value	Rated voltage	Breaking capacity	Time / cu	rrent characteristic
Style	Symbol	(A)	Marking symbol	(m Ω max.)	(V)	(А)	Current	Pre-arcing time
	151	0.15	0	2700	DC32			
	201	0.2	Z	1000]		
	251	0.25	С	750				
	321	0.315	D	620				
FCC10	401	0.4	Е	340				
1 00 10	501	0.5	F	290	DC30			
	631	0.63	I	210		35	250%	5 s max.
	801	0.8	K	150		35	25070	Jana.
	102	1.0	L	120				
	132	1.25	M	90				
	162	1.6	N	55	DC24			
FHC10	202	2.0	S	40				
111010	252	2.5	Т	36				
	322	3.15	U	26				
	151	0.15	OD	4000	DC50	35		5 s max.
	201	0.2	ZD	1800				
	251	0.25	CD	1000				
	321	0.315	DD	750				
	401	0.4	ED	330				
	501	0.5	FD	280			250%	
FCC16	631	0.63	ID	200				
	801	0.8	KD	130				
	102	1.0	LD	110				
	132	1.25	MD	85				
	162	1.6	ND	70				
	202	2.0	SD	55	D 000			
	252	2.5	TD	45	DC32	-		
FHC16	322	3.15	UD	26	DC24			
	402	4.0	XD 404	19				
	401	0.4	401	330				
	501	0.5	501	270				
	631	0.63	631	190				
ECCOO	801	0.8	801	130	DCEO			
FCC20	102	1.0	102	100	DC50			
	132 162	1.25	132 162	80 65		50	250%	5 s max.
	202	1.6 2.0	202	55				
	252	2.5	252	40				
	322	3.15	UD	26		1		
FHC20	402	4.0	XD	19	DC32			
111020	502	5.0	YD	14	DC24	1		
	302	ე.0	טז	14	DC24			

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Table-1(3)

Style	Rated current		Internal resistance value	Rated	Breaking capacity	Time / current characteristic		
	Symbol	(A)	Marking symbol	(mΩ max.)	(V)	(А)	Current	Pre-arcing time
	201	0.2	201	1800				
	251	0.25	251	1000				5 s max.
	321	0.315	321	750				
	401	0.4	401	350	DC64	50	250%	
	501	0.5	501	295				
	631	0.63	631	200				
FCC32	801	8.0	801	140				
	102	1.0	102	110				
	132	1.25	132	85				
	152	1.5	152	78				
	162	1.6	162	75				
	202	2.0	202	65				
	252	2.5	252	45				
	322	3.15	UD	26				
FHC32	402	4.0	XD	19	DC32			
	502	5.0	YD	14				

^{4.3} Working temperature range: -55 to +125(°C)

5. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Pac	kaging form	Standard packaging quantity / units	Application
В	Bulk (loose package)		1,000 pcs.	FCC10,16,20,32, FHC10,16,20,32
PA	Press pocket taping (paper taping)	8mm width, 2mm pitches	10,000 pcs.	FCC10, FHC10
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	FCC16,20,32, FHC16,20,32

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6. Dimensions

6.1 The resistor shall be of the design and physical dimensions in accordance with Figure-1 and Table-3.

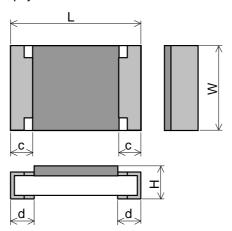


Figure-1

Table-3 Unit:mm W Style Н d С FCC10, FHC10 1.0±0.05 0.5±0.05 0.4±0.05 0.2 ± 0.1 0.25±0.10 0.8 +0.15 -0.05 FCC16, FHC16 1.6±0.1 0.45±0.10 0.3±0.15 0.3 ± 0.1 FCC20, FHC20 2.0±0.1 1.25±0.10 0.6±0.1 0.4±0.2 0.4±0.2 FCC32 0.6 ± 0.1 3.2±0.2 1.6±0.15 0.5 ± 0.25 0.5 ± 0.25 FHC32 0.65±0.10

6.2 Net weight (Reference)

Style	Net weight(mg)
FCC10, FHC10	0.8
FCC16, FHC16	2
FCC20, FHC20	6
FCC32	10
FHC32	11

7. Marking

The Marking symbol of Sub-clause 4.1 shall be marked on over coat side.

(Example)

Style	Optional code	Marking symbol	Content
FCC10		N	FCC10 162 AB
FHC10		T	FHC10 252 AB
FCC16	AB	SB	FCC16 202 AB
FHC16	۸۵	TB	FHC16 252 AB
FCC20		SB	FCC20 202 AB
FHC20		TB	FHC20 252 AB
FCC10		N	FCC10 162 AD
FHC10		U	FHC10 322 AD
FCC16		ND	FCC16 162 AD
FHC16	AD	UD	FHC16 322 AD
FCC20	۸۵	162	FCC20 162 AD
FHC20		UD	FHC20 322 AD
FCC32		162	FCC32 162 AD
FHC32		UD	FHC32 322 AD



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8. Performance

8.1 Unless otherwise specified, the standard range of atmospheric conditions for tests is as follows;

Ambient temperature: 5 °C to 35 °C, Relative humidity: 45 % to 85 %, Air presser: 86 kPa to 106 kPa

If there is any doubt the results, measurements shall be made within the following:

Ambient temperature: 20 °C \pm 2 °C, Relative humidity: 60 % to 70 %, Air presser: 86 kPa to 106 kPa

8.2 The performance shall be satisfied in Table-4.

Table 4(1)

		1abl c 4 (1)			
No.	Test items	Condition of test			quirements
1	Temperature rise	The fuse shall be mounted on the test substrate as shown in Figure–2.	75 °C ma	ax.	
		Measurement temp.: 10 °C to 30 °C			
		Test current: Rated current			
		The temperature at the hottest point on the surface of			
		the fuse shall be measured after temperature			
		equilibrium has been attained.	3.8.64		
2	Current carrying capacity	The fuse shall be mounted on the test substrate as	Without o	pening	
		shown in Figure—2.			
		Test current: 110 % of Rated current			
		Test temp.: 70 °C ± 2 °C			
2	Time / current characteristic	Test period: 1h	Optional	Current	Due ensire
3	Time / Current Characteristic	The fuse shall be mounted on the test substrate as shown in Figure –2.	code	Current	Pre-arcing time
		Test current shall be applied for continuously.	AB	200%	5 s max.
		rest current shall be applied for continuously.	AD	250%	5 s max.
			70	23076	Janax.
4	Terminal bond strength of	JIS C 60068-2-21 Ue1	Change of	of internal r	esistance:
	the face plating	The fuse shall be mounted on the test substrate as	±3%		
	3	shown in Figure-2.		dence o	f mechanical
		Bending value: 3 mm (Among the fulcrums: 90 mm)	damage.		
		Duration: 10 s ± 1 s			
5	Resistance to soldering	Test by a piece.	Change of	of internal r	esistance:
	heat	Temp. of solder bath: 260 °C ± 5 °C	±10%		
		Immersion time: $10 \text{ s} \pm 1 \text{ s}$	No evid	dence of	f appearance
		After immersion into solder, leaving the room temp.	damage		
		for 1h or more, and then measure the internal			
		resistance.			
		Reflow soldering			
		Pre-heating: 150 °C ~ 180 °C, 120 s max.			
		Peak: 260 °C ± 5 °C, 10 s max.			
		Refrow cycle: 2 times			
		After immersion into solder, leaving the room temp.			
		for 1h or more, and then measure the internal			
		resistance.			
6	Solderability	JIS C 60068-2-58			al immersed shall
	,	Test by a piece			ered with a new
		Flux: Rosin-Methanol	coating of	solder.	
		Temp. of solder: bath: 235 °C ± 5 °C			
		Immersion time: $2 s \pm 0.5 s$			

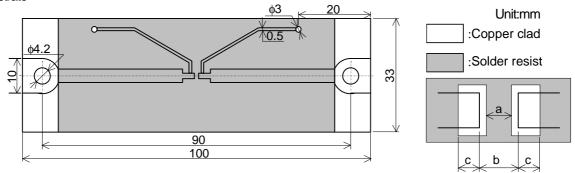
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Table-4(2)

No.	Test items	Condition of test	Performance requirements	
7	Rapid change temperature	JIS C 60068-2-14 Na	Change of internal resistance:	
		The fuse shall be mounted on the test substrate as	±10%	
		shown in Figure–2.	No evidence of appearance	
		Lower temperature: –55 °C	damage	
		Upper temperature: +125 °C		
		Duration of exposure at each temperature: 30 min.		
		Number of cycles: 5 cycles		
8	Endurance test	The fuse shall be mounted on the test substrate as	The voltage drop across the fuse	
		shown in Figure–2.	after the test shall not have	
		Test condition: Nominal ambient temp. and Relative	increased by more than 10 % of	
		humidity. the value measured before		
		Test potential:		
		1. Cycle of 1 h "ON" and 15 min. "OFF" at 1.05 times		
		rated current for 100 cycles.		
		2. After above the test, 1.25 times rated current for		
		1h.		

9. Test substrate



Style	Α	b	С
FCC10, FHC10	0.3	0.6	0.65
FCC16, FHC16	0.6	1.0	0.5
FCC20, FHC20	0.9	1.3	0.7
FCC32, FHC32	1.8	2.2	0.85

Figure-2 FCC, FHC TEST SUBSTRATE

Remark 1). Material: Epoxide woven glass

Thickness: 1. 6mm Thickness of copper clad: 0. 035mm

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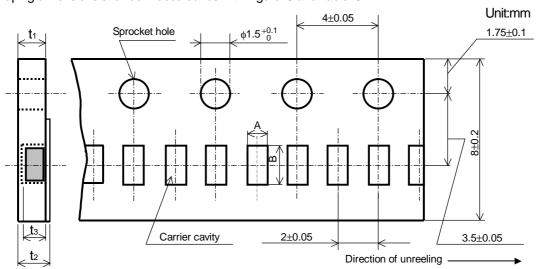
10. Taping

10.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010

10.2 Taping dimensions

10.2.1 Press pocket taping(8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.



 Figure—3

 Table—5
 Unit:mm

 Style
 A
 B
 t₁
 t₂
 t₃

 FCC10, FHC10
 0.65±0.1
 1.15±0.1
 0.6±0.05
 0.7max.
 0.5±0.05

10.2.2 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-4 and Table-6.

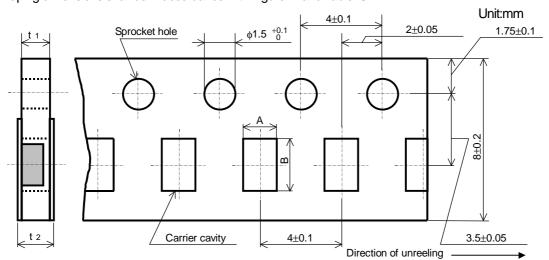
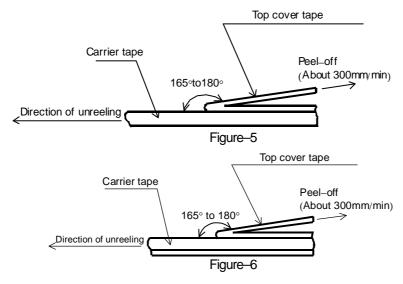


Figure-4

	Unit:mm			
Style	Α	В	t 1	t 2
FCC16, FHC16	1.15±0.15	1.9±0.2	0.6±0.1	0.8 max.
FCC20, FHC20	1.65±0.15	2.5±0.2	0.0.0.1	1.0 may
FCC32, FHC32	2.0±0.15	3.6±0.2	0.8±0.1	1.0 max.

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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following FCC10, FHC10:Figure–5,FCC16,20,32, FHC16,20,32 : Figure–6.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- In no case shall there be two or more consecutive components missing.
 The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The fuses shall be faced to upward at the over coating side in the carrier cavity.

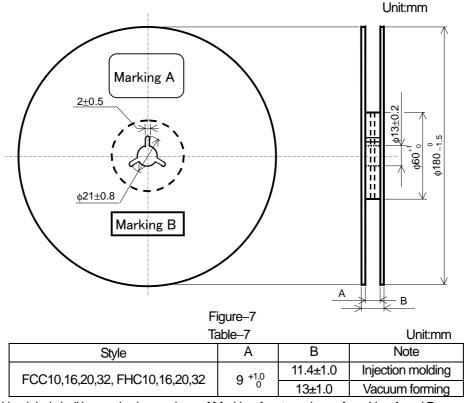


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10.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–7 and Table–7.

Plastic reel (Based on EIAJ ET-7200C)



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

10.4 Leader and trailer tape.

(Example)

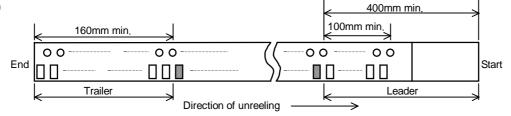


Figure-8

11. Marking on package

The label of a minimum package shall be legibly marked with follows.

11.1 Marking A

- (1) Classification (Style, Rated current, Optional code, Packaging form) (2) Quantity (3) Lot number
- (5) Manufacturer's name or trade mark (6) UL and /or C–UL recognized component mark (7) Others 11.2 Marking B (KAMAYA Control label)

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12. Recommended Derating for Rated Current

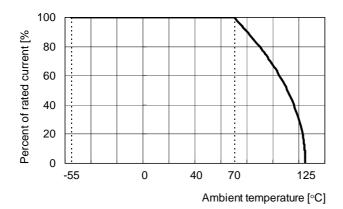
Nominal Derating

Option Code AB: Nominal Derating ≤ 70% of Rated Current

Option Code AD: Nominal Derating ≤ 80% of Rated Current

•Temperature Derating

Please refer to the following graph regarding the current derating value for ambient temperature.



Ex.) • If Optional code: AB (Rated Current: 1.0A) is used under ambient temperature 70°C Kamaya recommends, less than the current value derated as below,

Rated Current: 1.0A× (Nominal Derating: 70% × Temperature Derating: 100%) =0.7A

 If Optional code: AD (Rated Current: 1.0A) is used under ambient temperature 70°C Kamaya recommends, less than the current value derated as below,
 Rated Current: 1.0A× (Nominal Derating: 80% × Temperature Derating: 100%) =0.8A